IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Koji MISHIMA et al.

Serial No. 10/660,483

Filed September 12, 2003

METHOD AND APPARATUS FOR PLATING SUBSTRATE WITH COPPER

: Confirmation No. 6334

Docket No. 2003_1305

Group Art Unit 1742

Examiner William T. Leader

Mail Stop: Amendment

AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEES FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975

Sir:

Responsive to the Office Action of December 15, 2004, a Petition for a one-month extension of time being filed concurrently herewith, please amend the above-identified application as follows.